BLF544 UHF power MOS transistor Rev. 4 – 1 September 2015



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As of December 7th, 2015 BL RF Power of NXP Semiconductors will operate as an independent company under the new trade name Ampleon, which will be used in future data sheets together with new contact details.

In data sheets, where the previous Philips references is mentioned, please use the new links as shown below.

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If you have any questions related to the data sheet, please contact our nearest sales office (details via http://www.ampleon.com/sales).

Thank you for your cooperation and understanding,

Ampleon

BLF544

FEATURES

- High power gain
- · Easy power control
- Good thermal stability
- Gold metallization ensures excellent reliability
- Designed for broadband operation.

APPLICATIONS

• Communication transmitters in the UHF frequency range.

DESCRIPTION

N-channel enhancement mode vertical D-MOS power transistor encapsulated in a 6-lead, SOT171A flange package with a ceramic cap. All leads are isolated from the flange.

A marking code showing gate-source voltage (V_{GS}) information is provided for matched pair applications.

PINNING - SOT171A

PIN	DESCRIPTION
1	source
2	source
3	gate
4	drain
5	source
6	source

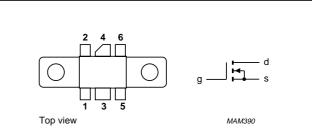


Fig.1 Simplified outline and symbol.

QUICK REFERENCE DATA

RF performance at T_h = 25 °C in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	P _L (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	20	>11	>50
CW, class-B	960	28	20	typ. 7	typ. 50

CAUTION

This product is supplied in anti-static packing to prevent damage caused by electrostatic discharge during transport and handling. For further information, refer to Philips specs.: SNW-EQ-608, SNW-FQ-302A and SNW-FQ-302B.

WARNING

Product and environmental safety - toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO disc is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions. After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with the general or domestic waste.

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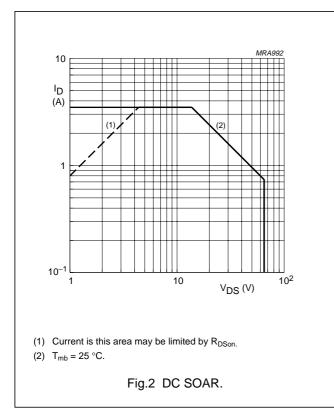
LIMITING VALUES

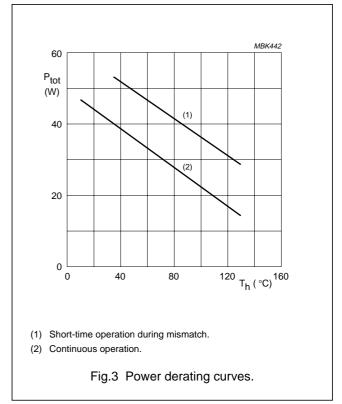
In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
V _{DS}	drain-source voltage		-	65	V
V _{GS}	gate-source voltage		_	±20	V
I _D	drain current (DC)		-	3.5	А
P _{tot}	total power dissipation	$T_{mb} \le 25 \ ^{\circ}C$	-	48	W
T _{stg}	storage temperature		-65	+150	°C
Tj	junction temperature		—	200	°C

THERMAL CHARACTERISTICS

SYMBOL	PARAMETER	VALUE	UNIT
R _{th j-mb}	thermal resistance from junction to mounting base	3.7	K/W
R _{th mb-h}	thermal resistance from mounting base to heatsink	0.4	K/W





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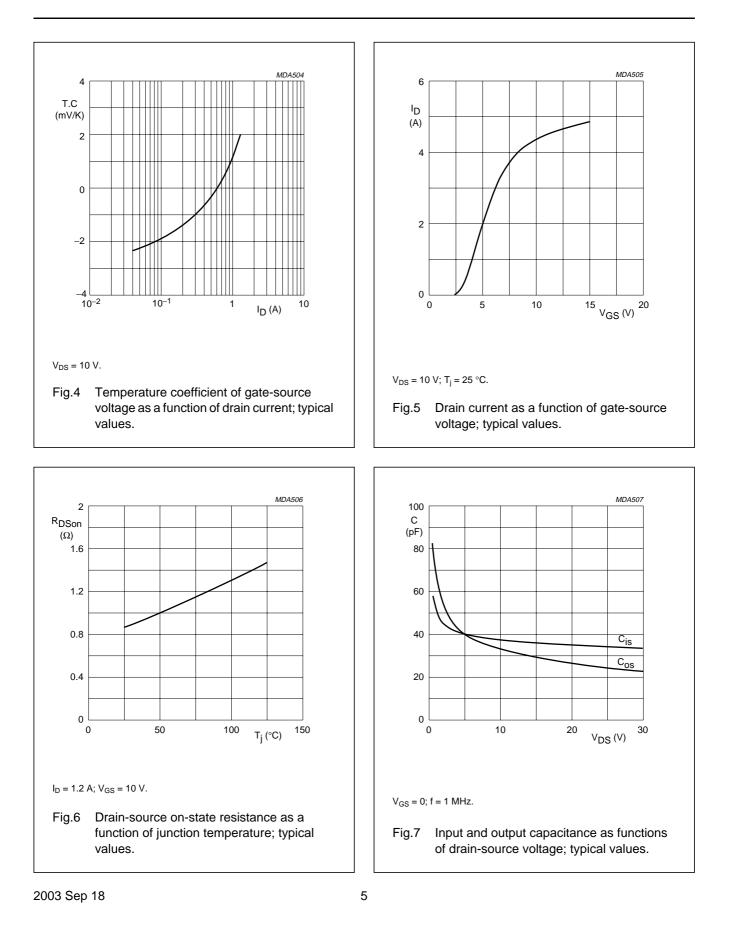
CHARACTERISTICS

 T_j = 25 °C unless otherwise specified.

SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
V _{(BR)DSS}	drain-source breakdown voltage	$V_{GS} = 0; I_D = 10 \text{ mA}$	65	-	-	V
I _{DSS}	drain-source leakage current	$V_{GS} = 0; V_{DS} = 28 V$	-	-	1	mA
I _{GSS}	gate-source leakage current	$V_{GS} = \pm 20 \text{ V}; V_{DS} = 0$	-	-	1	μA
V _{GSth}	gate-source threshold voltage	I _D = 40 mA; V _{DS} = 10 V	1	-	4	V
ΔV_{GSth}	gate-source voltage difference of matched pairs	I _D = 40 mA; V _{DS} = 10 V	-	-	100	mV
g _{fs}	forward transconductance	I _D = 1.2 A; V _{DS} = 10 V	600	900	-	mS
R _{DSon}	drain-source on-state resistance	I _D = 1.2 A; V _{GS} = 10 V	-	0.85	1.25	Ω
I _{DSX}	on-state drain current	V _{GS} = 15 V; V _{DS} = 10 V	-	4.8	-	A
C _{is}	input capacitance	V _{GS} = 0; V _{DS} = 28 V; f = 1 MHz	-	32	-	pF
C _{os}	output capacitance	$V_{GS} = 0; V_{DS} = 28 V; f = 1 MHz$	-	24	-	pF
C _{rs}	feedback capacitance	$V_{GS} = 0; V_{DS} = 28 V; f = 1 MHz$	_	6.4	-	pF

V_{GS} group indicator

GROUP		IITS /)	GROUP	LIMITS (V)		
	MIN.	MAX.		MIN.	MAX.	
А	2.0	2.1	0	3.3	3.4	
В	2.1	2.2	Р	3.4	3.5	
С	2.2	2.3	Q	3.5	3.6	
D	2.3	2.4	R	3.6	3.7	
E	2.4	2.5	S	3.7	3.8	
F	2.5	2.6	Т	3.8	3.9	
G	2.6	2.7	U	3.9	4.0	
Н	2.7	2.8	V	4.0	4.1	
J	2.8	2.9	W	4.1	4.2	
К	2.9	3.0	Х	4.2	4.3	
L	3.0	3.1	Y	4.3	4.4	
М	3.1	3.2	Z	4.4	4.5	
Ν	3.2	3.3				



MDA508 40 C_{rs} (pF) 30 20 10 0 0 10 20 30 $V_{\text{DS}}(V)$ $V_{GS} = 0$; f = 1 MHz. Fig.8 Feedback capacitance as a function of drain-source voltage; typical values.

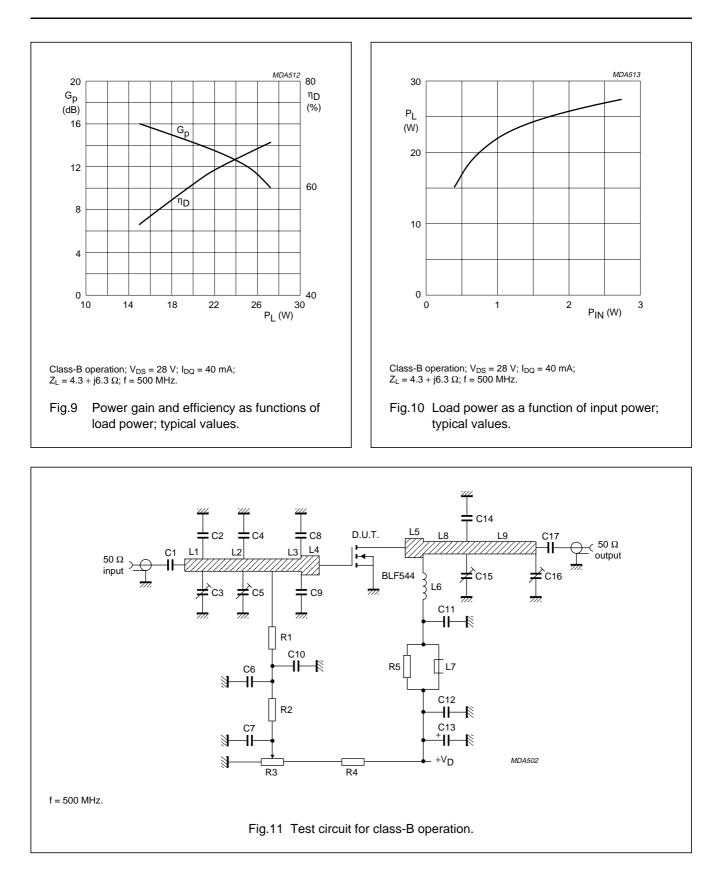
APPLICATION INFORMATION

 $T_h = 25 \text{ °C}$; $R_{th mb-h} = 0.4 \text{ K/W}$ unless otherwise specified. RF performance in a common source class-B circuit.

MODE OF OPERATION	f (MHz)	V _{DS} (V)	I _{DQ} (mA)	PL (W)	G _p (dB)	η _D (%)
CW, class-B	500	28	40	20	>11 typ. 14	>50 typ. 60
CW, class-B	960	28	40	20	typ. 7	typ. 50
CW, class-B	960	24	40	15	typ. 7	typ. 50

Ruggedness in class-B operation

The BLF544 is capable of withstanding a full load mismatch corresponding to VSWR = 50 : 1 through all phases under the following conditions: V_{DS} = 28 V; f = 500 MHz at rated output power.



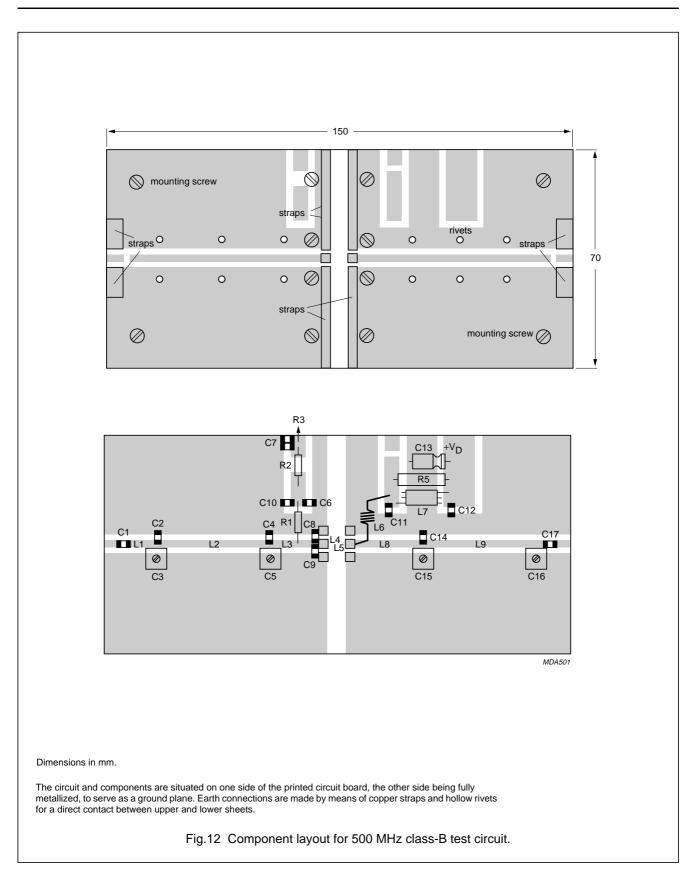
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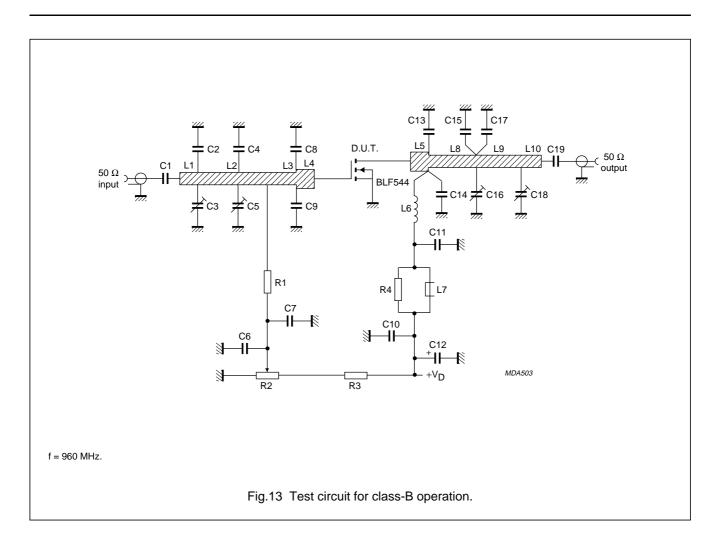
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1, C6, C11, C17	multilayer ceramic chip capacitor; note 1	390 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C3, C5	film dielectric trimmer	2 to 9 pF		2222 809 09002
C4	multilayer ceramic chip capacitor; note 2	27 pF; 50 V		
C7	multilayer ceramic chip capacitor	$2 \times 100 \text{ nF in}$ parallel; 50 V		2222 852 47104
C8, C9	multilayer ceramic chip capacitor; note 2	39 pF		
C10, C12	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C13	electrolytic capacitor	4.7 μF; 63 V		2222 030 38478
C14	multilayer ceramic chip capacitor; note 1	20 pF; 500 V		
C15, C16	film dielectric trimmer	2 to 18 pF		2222 809 09003
L1	stripline note 3	50 Ω	9.5 imes 2.5 mm	
L2	stripline note 3	50 Ω	$34.5 \times 2.5 \text{ mm}$	
L3	stripline note 3	50 Ω	$17.5 \times 2.5 \text{ mm}$	
L4, L5	stripline note 3	42 Ω	$3 \times 3 \text{ mm}$	
L6	4 turns enamelled 0.8 mm copper wire	31 nH	length 7.5 mm int. dia. 3 mm leads 2×5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L8	stripline note 3	50 Ω	$22 \times 2.5 \text{ mm}$	
L9	stripline note 3	50 Ω	$39.5 \times 2.5 \text{ mm}$	
R1, R2	0.4 W metal film resistor	1 kΩ		2322 151 11002
R3	10 turns cermet potentiometer	50 kΩ		
R4	0.4 W metal film resistor	140 kΩ		2322 151 11404
R5	1 W metal film resistor	10 Ω		2322 153 51009

List of components (see Figs 11 and 12).

Notes

- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 3. The striplines are on a double copper-clad printed circuit board, with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness $\frac{1}{32}$ inch.





BLF544

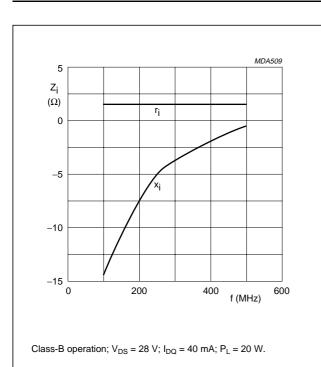
List of components	(see Figs 12 and 13)
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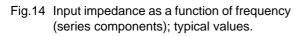
COMPONENT	DESCRIPTION	VALUE	DIMENSIONS	CATALOGUE NO.
C1	multilayer ceramic chip capacitor; note 1	68 pF; 500 V		
C2	multilayer ceramic chip capacitor; note 2	1.6 pF; 50 V		
C3, C5, C16, C18	film dielectric trimmer	1.4 to 5.5 pF		2222 809 09001
C4	multilayer ceramic chip capacitor; note 2	1 pF; 50 V		
C6	multilayer ceramic chip capacitor	10 nF; 50 V		2222 852 47103
C7, C11	multilayer ceramic chip capacitor; note 1	56 μF; 500 V		
C8, C9, C15, C17	multilayer ceramic chip capacitor; note 2	6.8 μF; 50 V		
C10	multilayer ceramic chip capacitor	100 nF; 50 V		2222 852 47104
C12	electrolytic capacitor	4.7 μF; 63 V		2222 030 38478
C13	multilayer ceramic chip capacitor; note 2	16 pF; 50 V		
C14	multilayer ceramic chip capacitor; note 2	18 pF; 50 V		
C19	multilayer ceramic chip capacitor; note 1	62 pF; 500 V		
L1, L8	stripline; note 3	50 Ω	6 × 2.5 mm	
L2	stripline; note 3	50 Ω	38×2.5 mm	
L3	stripline; note 3	50 Ω	17.5 × 2.5 mm	
L4, L5	stripline; note 3	42 Ω	$3 \times 3 \text{ mm}$	
L6	2 turns enamelled 1 mm copper wire	16 nH	length 3.4 mm int. dia. 3 mm leads 2×5 mm	
L7	grade 3B Ferroxcube RF choke			4312 020 36642
L9	stripline; note 3	50 Ω	21 × 2.5 mm	
L10	stripline; note 3	50 Ω	$34.5 \times 2.5 \text{ mm}$	
R1	0.4 W metal film resistor	15 kΩ		2322 151 11473
R2	10 turns potentiometer	50 kΩ		
R3	0.4 W metal film resistor	140 kΩ		2322 151 11404
R4	0.4 W metal film resistor	10 Ω		2322 153 51009

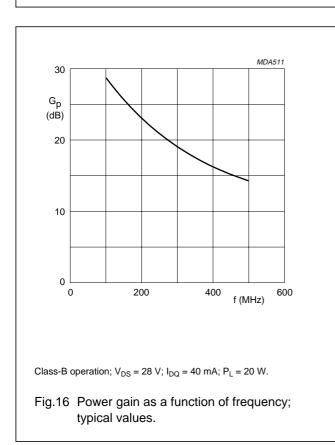
Notes

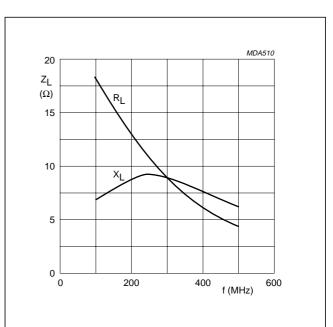
- 1. American Technical Ceramics (ATC) capacitor, type 100B or other capacitor of the same quality.
- 2. American Technical Ceramics (ATC) capacitor, type 100A or other capacitor of the same quality.
- 3. The striplines are on a double copper-clad printed-circuit board with glass microfibre reinforced PTFE ($\epsilon_r = 2.2$); thickness 1_{32} inch.

BLF544









Class-B operation; V_{DS} = 28 V; I_{DQ} = 40 mA; P_L = 20 W.

Fig.15 Load impedance as a function of frequency (series components); typical values.

Optimum input and load impedances

BLF544

BLF544 scattering parameters

 V_{DS} = 28 V; I_D = 40 mA; note 1

f (MHz)	s ₁₁		S	21	S 1	2	S ₂₂		
	s ₁₁	$\angle \Phi$	s ₂₁	$\angle \Phi$	s ₁₂	$\angle \Phi$	S ₂₂	$\angle \Phi$	
5	0.99	-14.0	13.60	171.0	0.02	81.0	0.89	-12.8	
10	0.98	-27.6	13.20	162.0	0.04	72.4	0.87	-25.3	
20	0.93	-52.0	11.90	146.0	0.07	57.1	0.82	-48.0	
30	0.88	-72.0	10.30	134.0	0.09	44.8	0.77	-66.6	
40	0.84	-87.7	8.93	124.0	0.10	35.2	0.72	-81.3	
50	0.81	-100.0	7.75	116.0	0.11	27.7	0.68	-93.0	
60	0.79	-110.0	6.78	110.0	0.12	21.6	0.66	-102.0	
70	0.77	-118.0	6.00	104.0	0.12	16.7	0.64	-109.0	
80	0.76	-124.0	5.36	99.8	0.12	12.5	0.63	-115.0	
90	0.75	-129.0	4.82	95.9	0.12	8.9	0.62	-120.0	
100	0.75	-133.0	4.37	92.3	0.13	5.7	0.61	-124.0	
125	0.74	-141.0	3.53	84.7	0.13	-1.1	0.61	-131.0	
150	0.74	-147.0	2.94	78.3	0.13	-6.6	0.61	-137.0	
175	0.74	-151.0	2.50	72.6	0.12	–11.5	0.62	-140.0	
200	0.75	-154.0	2.16	67.5	0.12	-15.8	0.64	-143.0	
250	0.77	-159.0	1.67	58.4	0.12	-23.3	0.67	-148.0	
300	0.78	-163.0	1.33	50.4	0.11	-29.7	0.70	-151.0	
350	0.80	-167.0	1.09	43.1	0.10	-35.3	0.73	-154.0	
400	0.82	-169.0	0.91	36.6	0.10	-40.3	0.75	-157.0	
450	0.84	-172.0	0.77	30.6	0.09	-44.7	0.78	-160.0	
500	0.85	-175.0	0.66	25.1	0.08	-48.6	0.80	-162.0	
600	0.89	-179.0	0.50	15.6	0.07	-55.2	0.84	-167.0	
700	0.90	177.0	0.39	7.5	0.06	-60.4	0.88	-170.0	
800	0.92	173.0	0.32	0.6	0.05	-64.3	0.90	-174.0	
900	0.93	169.0	0.26	-5.4	0.04	-67.3	0.92	-177.0	
1000	0.94	166.0	0.22	-10.8	0.04	-69.2	0.93	-179.0	

Note

1. For more extensive s-parameters see internet:

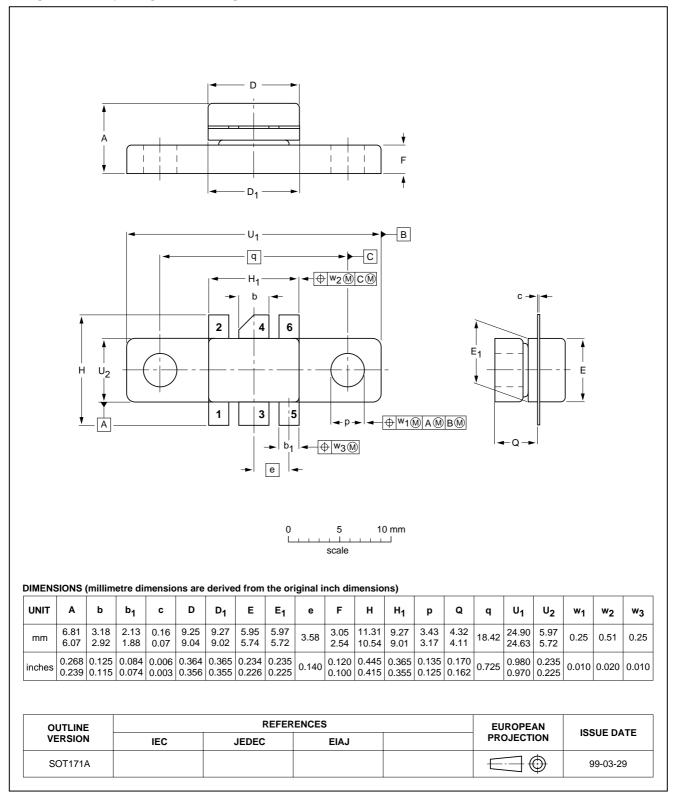
http://www.semiconductors.philips.com/markets/communications/wirelesscommunication/broadcast.

BLF544

UHF power MOS transistor

PACKAGE OUTLINE

Flanged ceramic package; 2 mounting holes; 6 leads



SOT171A

BLF544

DATA SHEET STATUS

LEVEL	DATA SHEET STATUS ⁽¹⁾	PRODUCT STATUS ⁽²⁾⁽³⁾	DEFINITION
1	Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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